# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6008220

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SEUNGRI CHOI	03/10/2020
SEMIN BANG	03/10/2020
MYUNGHEE LEE	03/10/2020

## **RECEIVING PARTY DATA**

Name:	SEOUL SEMICONDUCTOR CO., LTD.	
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City:	ANSAN-SI	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	15429	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	35506573

## **CORRESPONDENCE DATA**

**Fax Number:** (703)288-5139

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: H.C. PARK & ASSOCIATES, PLC

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TTORNEY DOCKET NUMBER: D1136US00	
NAME OF SUBMITTER: HAE-CHAN PARK	
SIGNATURE:	/Hae-Chan Park/
DATE SIGNED:	03/11/2020
This document serves as an Oath/Declaration (37 CFR 1.63).	

**Total Attachments: 3** 

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PATENT REEL: 052081 FRAME: 0559

## ASSIGNMENT SERVING AS DECLARATION PER 37 C.F.R. § 1.63(e)

	As a below named inventor and Assignor, I declare that:
	This assignment and declaration are directed to:
	The attached application entitled <b>LIGHT EMITTING DIODE PACKAGE</b> having attorney docket number <u>D1136US00</u> ("Application"), which claims priority from: Korean Design Application No. <u>30-2018-0017551</u> , filed <u>April 13, 2018</u> .
	As amended on (if applicable);
	The above-identified Application was made or authorized to be made by me.
in the	I believe that I am the original inventor or an original joint inventor of a claimed invention Application.
punisi both.	I hereby acknowledge that any willful false statement made in this declaration is hable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or
manu	Whereas, Assignor has invented a new, original and ornamental design for an article of facture ("Invention") disclosed in the Application,
to:	Whereas, Assignor desires to convey all rights, titles, and interests in and to the same
	Seoul Semiconductor Co., Ltd. 97-11, Sandan-ro 163beon-gil Danwon-gu, Gyeonggi-do Ansan-si 15429 Republic of Korea

Seoul Semiconductor Co., Ltd. herein further referred to as ("Assignee").

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration, Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.



Docket No. D1136US00

Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.

IN WITNESS WHEREOF, Inventor and Assignor has hereunto set hand and seal.

First Inventor's and Assignor's Name:	SeungRi CHOI
Address:	97-11, Sandan-ro, 163beon-gil Danwon-gu Ansan-si, Gyeonggi-do Republic of Korea ₹√5, ∀
First Inventor's and Assignor's Signature:	3
Date:	50. 3. 10
Second Inventor's and Assignor's Name:	SeMin BANG
Address:	97-11, Sandan-ro, 163beon-gil
	Danwon-gu Ansan-si, Gyeonggi-do
	Republic of Korea
	,
Second Inventor's and Assignor's	44 kn 191
Signature:	
Date:	20.7.10



Docket No. <u>D1136US00</u>

Third Inventor's and Assignor's Name:	MyungHee LEE
Address:	97-11, Sandan-ro, 163beon-gil Danwon-gu Ansan-si, Gyeonggi-do Republic of Korea
Third Inventor's and Assignor's Signature	Construction of the second of
Date:	376

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**RECORDED: 03/11/2020**